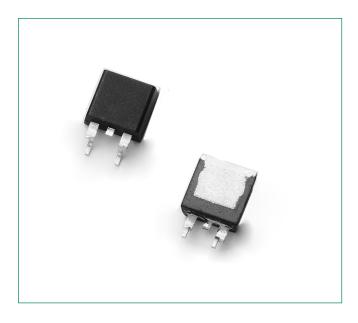


MCR12DCM, MCR12DCN





Pin Out



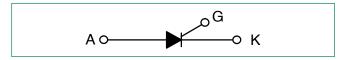
Description

This thyristor is designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gatecontrolled devices are needed.

Features

- Small Size
- Passivated Die for Reliability and Uniformity
- Low Level Triggering and Holding Characteristics
- Epoxy Meets rating UL Recognized compound meets flammability rating V-0.
- ESD Ratings: Human Body Model, 3B > 8000 V Machine Model, C > 400 V
- Pb-Free Packages are Available

Functional Diagram



Additional Information









Maximum Ratings (T_J = 25°C unless otherwise noted) Rating **Symbol** Value Unit MCR12DCM $\mathrm{V}_{_{\mathrm{DRM}}}$ 600 Peak Repetitive Off-State Voltage (Note 1) (- 40 to 110°C, Sine Wave, 50 to 60 Hz, Gate Open) MCR12DCN V_{RRM} 800 On-State RMS Current 12 Α I_{T (RMS)} (180° Conduction Angles; T_c = 90°C) Average On-State Current Α 7.8 $I_{T(AV)}$ (180° Conduction Angles; T_C = 90°C) Peak Non-Repetitive Surge Current I_{TSM} 100 Α (1/2 Cycle, Sine Wave 60 Hz, T = 125°C) Circuit Fusing Consideration (t = 8.3 ms) I^2t 41 A²sec Forward Peak Gate Power P_{GM} 5.0 W (Pulse Width \leq 10 µsec,T_C = 90°C) Forward Average Gate Power P_{GM (AV)} 0.5 W $(t = 8.3 \text{ msec}, T_{c} = 90^{\circ}\text{C})$ Forward Peak Gate Current 2.0 Α (Pulse Width \leq 1.0 μ sec, T_c = 90°C) °C -40 to 125 Τ, Operating Junction Temperature Range Storage Temperature Range -40 to 150 °C $\mathsf{T}_{\mathrm{stg}}$

Thermal Characteristics

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	Re _{JC}	2.2	
Thermal Resistance, Junction-to-Ambient	R _{e_{JA}}	88	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\Theta_{JA}}$	80	
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	T _L	260	°C

Electrical Characteristics - **OFF** $(T_j = 25^{\circ}C)$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current ($V_{AK} = Rated V_{DRM}$	T _J = 25°C	I _{DRM}	-	-	0.01	m ^
or V _{RRM} Gate Open)	T _J = 125°C	IRRM	-	-	5.0	mA

Electrical Characteristics - ON (T₁ = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Forward On-State Voltage (Note 2) (I _{TM} = 16 A)		V _{TM}	_	1.3	1.9	V
Gate Trigger Current (Continuous dc)	T _J = 25°C	I _o _	2.0	7.0	20	mA
$(V_D = 12 \text{ V}; R_L = 100 \Omega)$	T _J = -40°C		_	_	40	IIIA
Gate Trigger Voltage (Continuous dc)	T _J = 25°C		0.5	0.65	1.0	V
$(V_D = 12 \text{ V}, R_L = 100 \Omega)$	are higger voltage (Continuous dC) $V_D = 12 \text{ V, R}_L = 100 \Omega$		_	_	2.5	V
Gate Non-Trigger Voltage $(V_D = 12 \text{ V}, R_L = 100 \Omega)$	T _J = 125°C	V _{GD}	0.2	_	_	V
Holding Current	T _J = 25°C	I _H	4.0	22	40	A
$(V_D = 12 \text{ V}, \text{ Gate Open, Initiating Current} = 200 \text{ mA})$	T _J = -40°C		_	_	80	mA
Latch Current (V _D = 12 V, I _C = 20 μA, T _I = 25°C)			4.0	22	40	mA
$(V_D = 12 \text{ V, } I_G = 20 \text{ µA, } I_J = 20 \text{ C})$ $(V_D = 12 \text{ V, } I_G = 40 \text{ µA, } T_J = -40^{\circ}\text{C})$		'L	_	_	80	

Maximum ratings are those values beyond which component damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, component functional operation is not implied, damage may occur and reliability may be affected.

1. V..., and V..., for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent.

V_{DBM} and V_{BBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



Dynamic Characteristics Characteristic **Symbol** Min Тур Max Unit Critical Rate of Rise of Off-State Voltage dv/dt 50 200 V/µs $(V_D = Rated V_{DRM} Exponential Waveform, Gate Open, T_J = 125°C)$

- 2. These ratings are applicable when surface mounted on the minimum pad sizes recommended.
- 3. 1/8* from case for 10 seconds.
 4. Pulse Test: Pulse Width ≤ 2.0 msec, Duty Cycle ≤ 2%.

Voltage Current Characteristic of SCR

Symbol	Parameter		
V_{DRM}	Peak Repetitive Forward Off State Voltage		
I _{DRM}	Peak Forward Blocking Current		
V _{RRM}	Peak Repetitive Reverse Off State Voltage		
I _{RRM}	Peak Reverse Blocking Current		
V _{TM}	Maximum On State Voltage		
I _H	Holding Current		

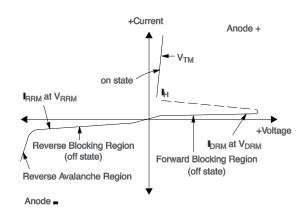


Figure 1. Average RMS Current Derating

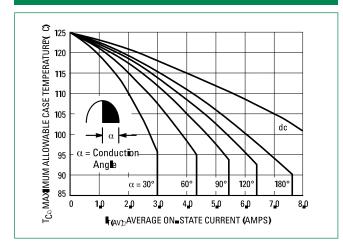


Figure 2. On-State Power Dissipation

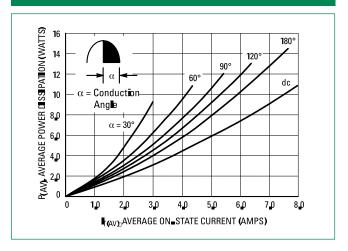




Figure 3. On-State Characteristics

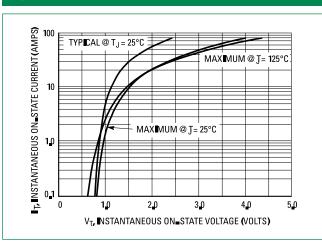


Figure 4. Transient Thermal Response

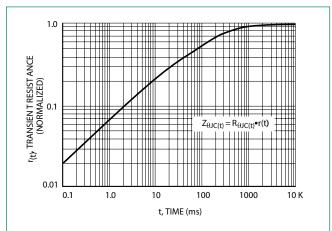


Figure 5. Typical Gate Trigger Current vs Junction Temperature

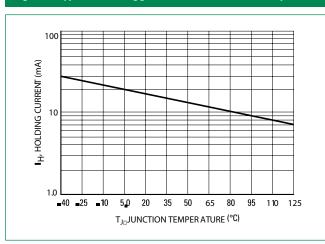


Figure 6. Typical Gate Trigger Voltage vs Junction Temperature

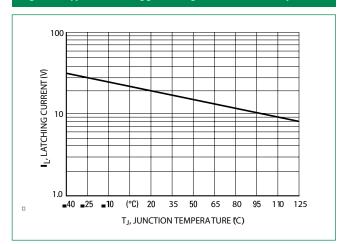


Figure 7. Typical Holding Current vs Junction Temperature

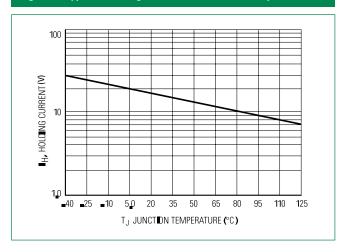
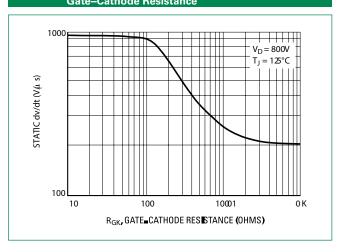
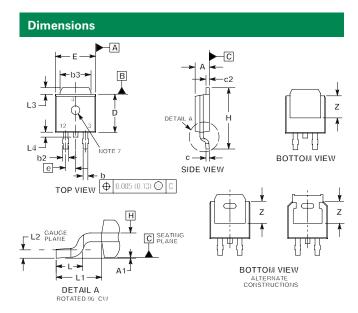


Figure 9. Exponential Static dv/dt vs Gate-Cathode Resistance





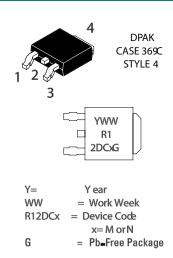


Inches			Millimeters		
Dim	Inches		winimeters		
	Min	Max	Min	Max	
А	0.087	0.094	2.20	2.40	
A1	0.000	0.005	0.00	0.12	
b	0.022	0.030	0.55	0.75	
b2	0.026	0.033	0.65	0.85	
b3	0.209	0.217	5.30	5.50	
С	0.019	0.023	0.49	0.59	
c2	0.019	0.023	0.49	0.59	
D	0.213	0.224	5.40	5.70	
Е	0.252	0.260	6.40	6.60	
е	0.0	0.091		30	
Н	0.374	0.406	9.50	10.30	
L	0.058	0.070	1.47	1.78	
L1	0.1	0.114		90	
L2	0.019	0.023	0.49	0.59	
L3	0.053	0.065	1.35	1.65	
L4	0.028	0.039	0.70	1.00	
Z	0.154	-	3.90	-	

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

${\tt 2.~CONTROLLING~DIMENSION:~INCH.}\\$

Part Marking System



Pin Assignment				
1	Cathode			
2	Anode			
3	Gate			
4	Anode			

Ordering Information

Device	Package	Shipping
MCR12DCMT4	DPAK	
MCR12DCMT4G	DPAK (Pb-Free)	2500 /
MCR12DCNT4	TO-220AB	Tape & Reel
MCR12DCNT4G	TO-220AB (Pb-Free)	

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